



Data sheet acquired from Harris Semiconductor
SCHS056

CD4071B, CD4072B, CD4075B Types

CMOS OR Gates

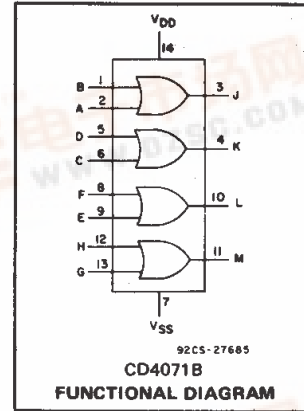
High-Voltage Types (20-Volt Rating)

- CD4071B Quad 2-Input OR Gate
- CD4072B Dual 4-Input OR Gate
- CD4075B Triple 3-Input OR Gate

■ CD4071B, CD4072B, and CD4075B OR gates provide the system designer with direct implementation of the positive-logic OR function and supplement the existing family of CMOS gates. The CD4071, CD4072, and CD4075 types are supplied in 14-lead dual-in-line ceramic packages (D and F suffixes), 14-lead dual-in-line plastic packages (E suffix), and in chip form (H suffix).

Features:

- Medium-Speed Operation- t_{PLH} , $t_{PHL} = 60$ ns (typ.) at $V_{DD} = 10$ V
- 100% tested for quiescent current at 20 V
- Maximum input current of $1 \mu A$ at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Standardized, symmetrical output characteristics
- Noise margin (over full package temperature range)
 - 1 V at $V_{DD} = 5$ V
 - 2 V at $V_{DD} = 10$ V
 - 2.5 V at $V_{DD} = 15$ V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"



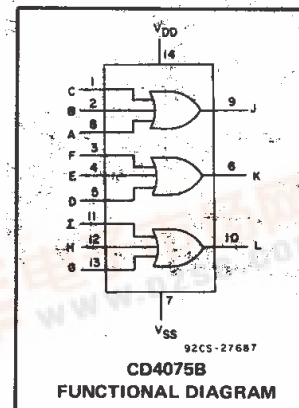
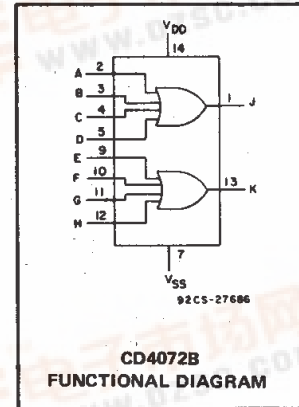
RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC | LIMITS | | UNITS |
|---|--------|------|-------|
| | MIN. | MAX. | |
| Supply-Voltage Range (For T_A = Full Package-Temperature Range) | 3 | 18 | V |

STATIC ELECTRICAL CHARACTERISTICS

| CHARACTERISTIC | CONDITIONS | | | LIMITS AT INDICATED TEMPERATURES (°C) | | | | | | | UNITS |
|---|------------|--------------|--------------|---------------------------------------|-----------|---------|---------|-------|---------------|-----------|---------|
| | V_O (V) | V_{IN} (V) | V_{DD} (V) | -55 | -40 | +85 | +125 | +25 | | | |
| | | | | | | | | Min. | Typ. | Max. | |
| Quiescent Device Current, I_{DD} Max. | - | 0.5 | 5 | 0.25 | 0.25 | 7.5 | 7.5 | - | 0.01 | 0.25 | μA |
| | - | 0.10 | 10 | 0.5 | 0.5 | 15 | 15 | - | 0.01 | 0.5 | |
| | - | 0.15 | 15 | 1 | 1 | 30 | 30 | - | 0.01 | 1 | |
| | - | 0.20 | 20 | 5 | 5 | 150 | 150 | - | 0.02 | 5 | |
| Output Low (Sink) Current I_{OL} Min. | 0.4 | 0.5 | 5 | 0.64 | 0.61 | 0.42 | 0.36 | 0.51 | 1 | - | mA |
| | 0.5 | 0.10 | 10 | 1.6 | 1.5 | 1.1 | 0.9 | 1.3 | 2.6 | - | |
| | 1.5 | 0.15 | 15 | 4.2 | 4 | 2.8 | 2.4 | 3.4 | 6.8 | - | |
| Output High (Source) Current, I_{OH} Min. | 4.6 | 0.5 | 5 | -0.64 | -0.61 | -0.42 | -0.36 | -0.51 | -1 | - | mA |
| | 2.5 | 0.5 | 5 | -2 | -1.8 | -1.3 | -1.15 | -1.6 | -3.2 | - | |
| | 9.5 | 0.10 | 10 | -1.6 | -1.5 | -1.1 | -0.9 | -1.3 | -2.6 | - | |
| | 13.5 | 0.15 | 15 | -4.2 | -4 | -2.8 | -2.4 | -3.4 | -6.8 | - | |
| Output Voltage: Low-Level, V_{OL} Max. | - | 0.5 | 5 | 0.05 | | | | - | 0 | 0.05 | V |
| | - | 0.10 | 10 | 0.05 | | | | - | 0 | 0.05 | |
| | - | 0.15 | 15 | 0.05 | | | | - | 0 | 0.05 | |
| Output Voltage: High-Level, V_{OH} Min. | - | 0.5 | 5 | 4.95 | | | | 4.95 | 5 | - | V |
| | - | 0.10 | 10 | 9.95 | | | | 9.95 | 10 | - | |
| | - | 0.15 | 15 | 14.95 | | | | 14.95 | 15 | - | |
| Input Low Voltage, V_{IL} Max. | 0.5, 4.5 | - | 5 | 1.5 | | | | - | - | 1.5 | V |
| | 1, 9 | - | 10 | 3 | | | | - | - | 3 | |
| | 1.5, 13.5 | - | 15 | 4 | | | | - | - | 4 | |
| Input High Voltage, V_{IH} Min. | 4.5 | - | 5 | 3.5 | | | | 3.5 | - | - | V |
| | 9 | - | 10 | 7 | | | | 7 | - | - | |
| | 13.5 | - | 15 | 11 | | | | 11 | - | - | |
| Input Current I_{IN} Max. | - | 0.18 | 18 | ± 0.1 | ± 0.1 | ± 1 | ± 1 | - | $\pm 10^{-5}$ | ± 0.1 | μA |



CD4071B, CD4072B, CD4075B Types

MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, (V_{DD})

Voltages referenced to V_{SS} Terminal -0.5V to +20V

INPUT VOLTAGE RANGE, ALL INPUTS -0.5V to $V_{DD} + 0.5V$

DC INPUT CURRENT, ANY ONE INPUT $\pm 10\text{mA}$

POWER DISSIPATION PER PACKAGE (P_D):

For $T_A = -55^\circ\text{C}$ to $+100^\circ\text{C}$ 500mW

For $T_A = +100^\circ\text{C}$ to $+125^\circ\text{C}$ Derate Linearly at $12\text{mW}/^\circ\text{C}$ to 200mW

DEVICE DISSIPATION PER OUTPUT TRANSISTOR

FOR $T_A = \text{FULL PACKAGE-TEMPERATURE RANGE (All Package Types)}$ 100mW

OPERATING-TEMPERATURE RANGE (T_A) -55°C to $+125^\circ\text{C}$

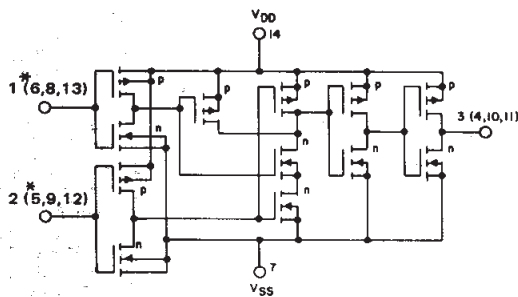
STORAGE TEMPERATURE RANGE (T_{stg}) -65°C to $+150^\circ\text{C}$

LEAD TEMPERATURE (DURING SOLDERING):

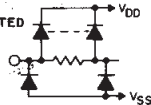
At distance $1/16 \pm 1/32$ inch ($1.59 \pm 0.79\text{mm}$) from case for 10s max $+265^\circ\text{C}$

DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^\circ\text{C}$, Input $t_r, t_f = 20\text{ ns}$, and $C_L = 50\text{ pF}$, $R_L = 200\text{ k}\Omega$

| CHARACTERISTIC | TEST CONDITIONS | ALL TYPES LIMITS | | | UNITS |
|--|-----------------|------------------|------|------|-------|
| | | V_{DD} VOLTS | TYP. | MAX. | |
| Propagation Delay Time, t_{PHL}, t_{PLH} | | 5 | 125 | 250 | ns |
| | | 10 | 60 | 120 | |
| | | 15 | 45 | 90 | |
| Transition Time, t_{THL}, t_{TLH} | | 5 | 100 | 200 | ns |
| | | 10 | 50 | 100 | |
| | | 15 | 40 | 80 | |
| Input Capacitance, C_{IN} | Any Input | — | 5 | 7.5 | pF |

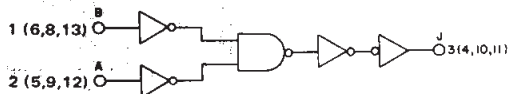


* ALL INPUTS ARE PROTECTED BY CMOS PROTECTION NETWORK



92CS-29114

Fig. 3 - Schematic diagram for CD4071B (1 of 4 identical gates).



92CS-29139

Fig. 5 - Logic diagram for CD4071B (1 of 4 identical gates).

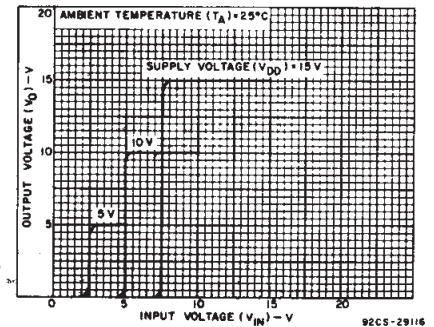


Fig. 1 - Typical voltage transfer characteristics.

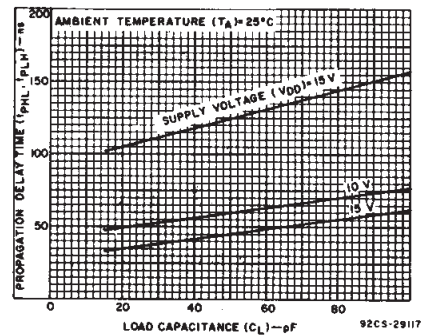


Fig. 2 - Typical propagation delay time as a function of load capacitance.

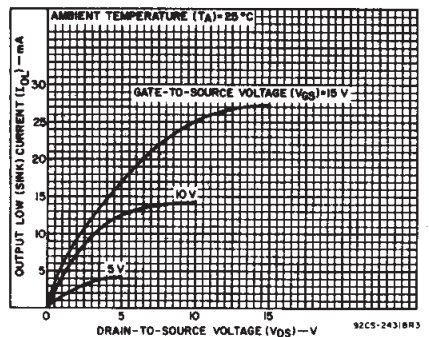


Fig. 4 - Typical output low (sink) current characteristics.

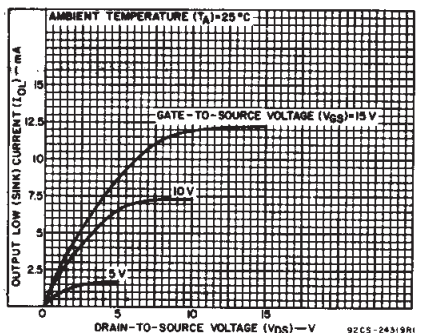


Fig. 6 - Minimum output low (sink) current characteristics.

CD4071B, CD4072B, CD4075B Types

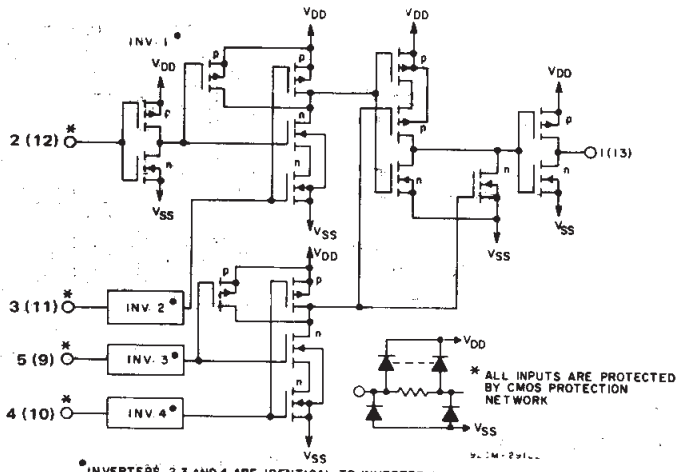


Fig. 7 - Schematic diagram for CD4072B (1 of 2 identical gates).

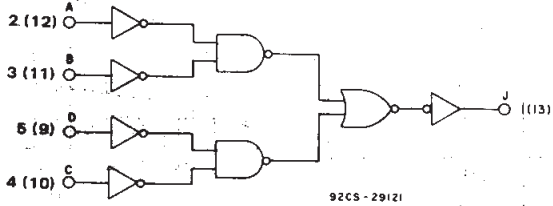


Fig. 9 - Logic diagram for CD4072B (1 of 2 identical gates).

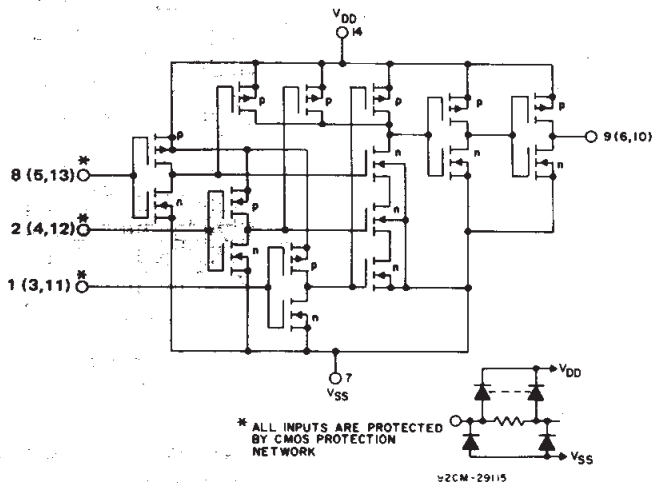


Fig. 11 - Schematic diagram for CD4075B (1 of 3 identical gates).

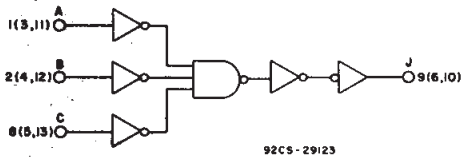


Fig. 13 - Logic diagram for CD4075B (1 of 3 identical gates).

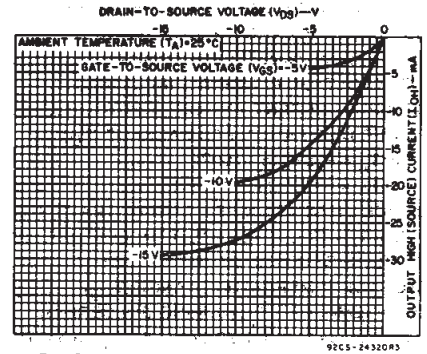


Fig. 8 - Typical output high (source) current characteristics.

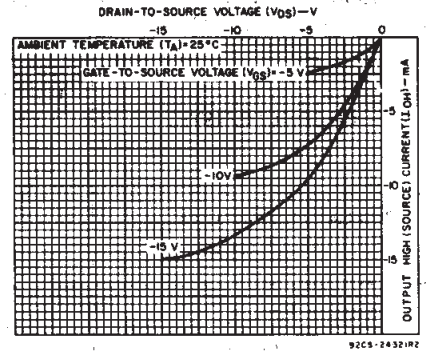


Fig. 10 - Minimum output high (source) current characteristics.

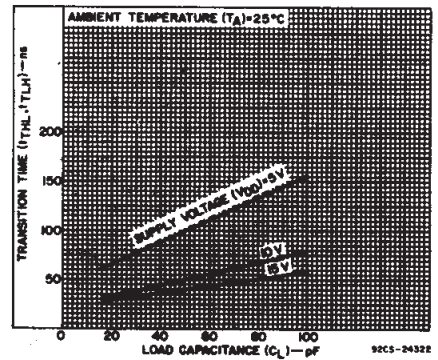


Fig. 12 - Typical transition time as a function of load capacitance.

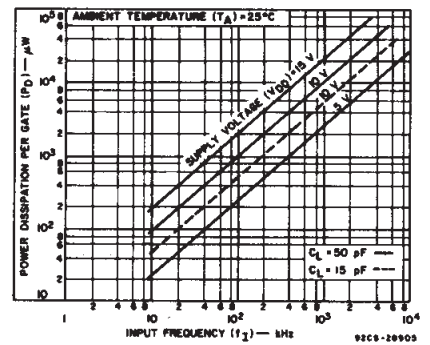


Fig. 14 - Typical dynamic power dissipation as a function of frequency.

CD4071B, CD4072B, CD4075B Types

TERMINAL ASSIGNMENTS (TOP VIEW)

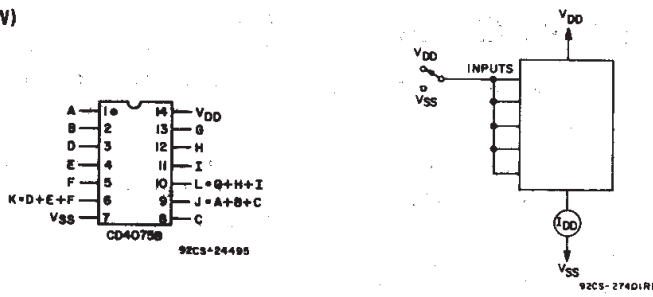
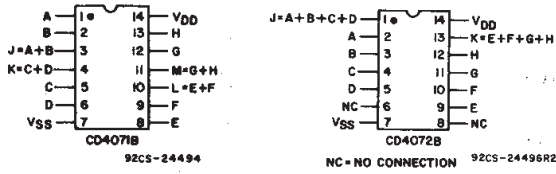


Fig. 15 - Quiescent device current test circuit.

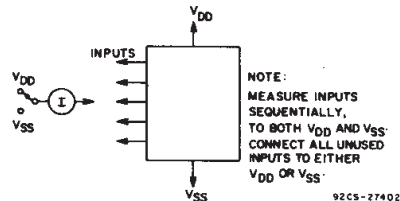


Fig. 16 - Input current test circuit.

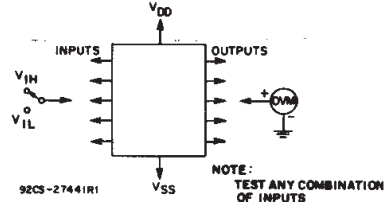
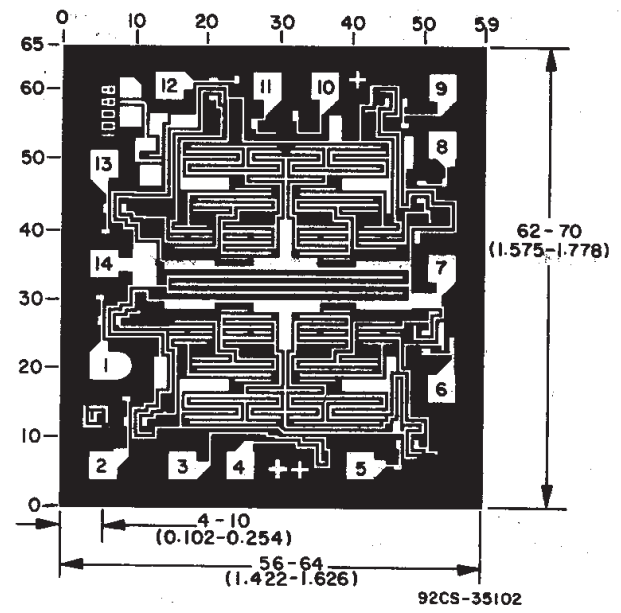
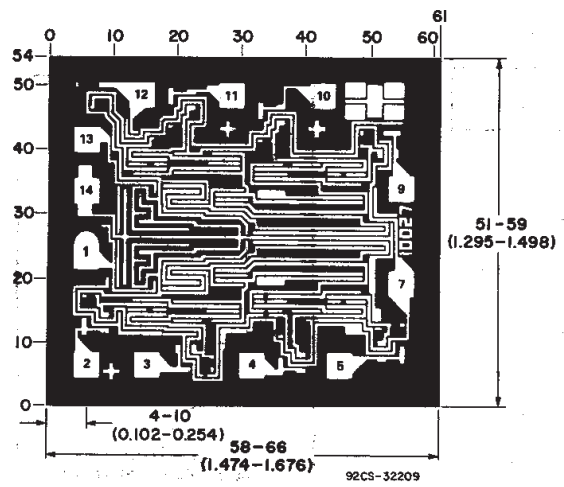


Fig. 17 - Input-voltage test circuit.

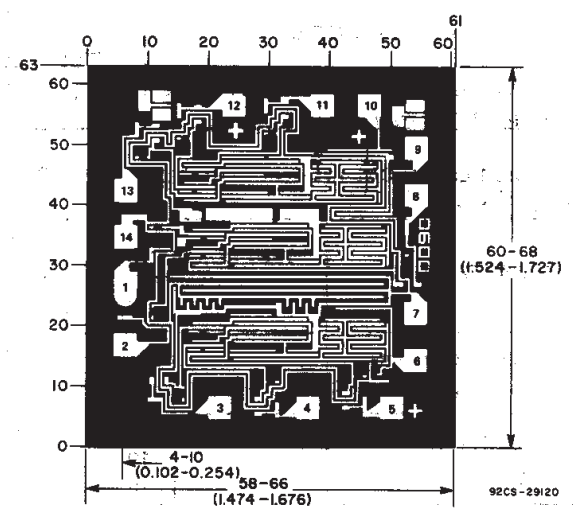
Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch).



Chip dimensions and pad layout for CD4071B.



Chip dimensions and pad layout for CD4072B.



Chip dimensions and pad layout for CD4075B.

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